# Cyberbond

# **Apollo** 2241

### **TECHNICAL DATA SHEET**

superior shock and thermal resistance when bonding rubbers, metals, and plastics in harsh environments, and displays excellent strength and flexibility on a variety of substrates. Apollo 2241 is certified to ISO 10993-5 for biocompatibility, making it appropriate for use in medical

Apollo 2241 is a black, high viscosity, rubber-toughened ethyl cyanoacrylate adhesive. It provides applications.

Physical Properties - Monomer (Uncured)				
Base Compound	Ethyl			
Appearance	Black			
Viscosity	2500 +/- 500 cPs			
Specific Gravity	1.06 g/cc			
Flash Point	85°C/ 185°F			
Shelf Life	9 mo			
Storage Condition	15.5°C/ 60°F			
RoHS-Compliant	yes			
Physical Properties - Polymer (Cured)				
Full Cure Time	24 hours			
Appearance	Black			
Service Temp Range	-55 to 140 °C ( -67 to 284 °F)			

Hot Strength (%RT strength, tested at temperature)					
120% +					
100%					
80%					
60%					
40%					
20%					
0%	1		1	ı	
	-40°C	0°C	50°C	100°C	130°C

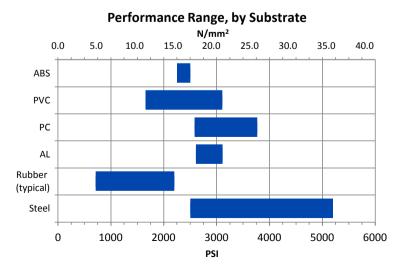
<b>Setting Time</b>		
Steel	30 - 90	seconds
ABS	7 - 13	seconds
EPDM	7 - 13	seconds
Wood	> 40	

Performance of Cured Adhesive						
Substrate	N/mm²			PSI		
Steel	17.2	to	35.9	2500	to	5200
Rubber*	4.9	to	15.2	710	to	2200
AL	18.0	to	21.5	2610	to	3115
PC**	17.8	to	26.0	2585	to	3770
PVC**	11.4	to	21.4	1655	to	3110
ABS**	15.5	to	17.2	2250	to	2500



<sup>\*\*</sup>Tested to ASTM 4501

<sup>\*\*\*</sup>n/r = not recommended

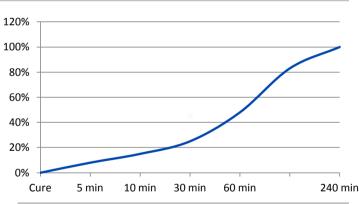


# Time Until Full Cure (% of RT strength)

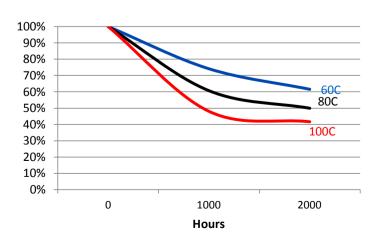
**Specifications and Approvals** 

Mil-A-46050C, Type II Class III

10993-5



Heat Aging (aged at temp indicated and tested @ 22°C)



#### **Solvent Resistance**

Solvent	Example	Resistance	
Alcohol	Ethanol, Methanol	+++	
Ester (aromatic)	Ethylacetate		
Ketone (aromatic)	Acetone, Benzophenone		
Aliphatic			
hydrocarbon	Petrol, Heptanes, Hexane	+ + -	
(alkanes)			
Aromatic	Benzyl, Toluol, Xylol	++-	
hydrocarbons	Benzyi, Toldol, Aylor		
Halogenated	Methylenchloride,		
hydrocarbons	Chloroform, Chlorobenzol		
•	•		
	Nitrite, muriatic acid,	+ + + ( if	
Weak aqueous acid	sulphuric acid, phosphoric	concentrated)	
	acid		
Week envelope	sodium hydroxide	+ + + ( if	
Weak aqueous base	solution, caustic potash	concentrated)	

#### **General Instructions**

Surfaces to be bonded should be clean and dry. Dispense a drop or drops to one surface only. Apply only enough to leave a thin film layer after compression. Press parts together and hold firmly for a few seconds. Good contact is essential. An adequate bond develops in less that one minute and maximum strength is attained in 24 hours. Wipe off excess adhesive from the top of the container and recap. Apollo products if left uncapped may deteriorate by contamination from moisture in the air. Because Apollo products cure by polymerization, whitening may appear on the surface of the container or the bonded materials. This will not affect adhesive performance.

## **Curing Performance**

Ambient surface moisture initiates the curing process. Handling strength is reached in a short time, and will vary based on environmental conditions, bond line gap, and other factors. Product will continue to cure for at least 24 hours before full strength and solvent resistance is developed.

### Storage

Products should be stored unopened in a cool, dry place out of direct sunlight. Products should be kept at room temperature away from direct light. Protect from extreme heat or cold, do not refrigerate.

#### Note

The data contained herein are furnished for information only and are believed to be reliable. Cyberbond cannot assume responsibility for the results obtained by others over whose method Cyberbond does not control. It is the user's responsibility to determine suitability for the product or of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, Cyberbond specifically disclaims all warranties of merchantability or fitness for a particular purpose arising from sale or use of Cyberbond products. Cyberbond specifically disclaims any liability for consequential or incidental damages of any kind, including loss of profits. The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Cyberbond patents which may cover such processes or compositions. We recommend that each prospective user test the proposed application to determine its suitability for the purpose intended prior to incorporating any product or application in its manufacturing process using the data as a guide.

# For safe handling information on this product, consult the Material Safety Data Sheet (MSDS)

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